









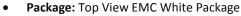


- ► EMC 2-PIN SMD
- ▶ 3020 0.52t
- Cool White (6500K)

N0W20S61







Forward Current: 150mA Forward Voltage (typ.): 3.1V

3020 EMC Series

Luminous Flux (typ.): 70lm@150mA

Colour: Cool White

Colour Temperature (CCT): 6500K

Viewing angle: 110°

Materials:

Die: InGaN

Resin: Silicon (Yellow Diffused)

Package: EMC

Operating Temperature: -40~+85°C Storage Temperature: -40~+85°C **Electrostatics Discharge: 1000V**

Grouping parameters:

Forward Voltage

Luminous Flux

CIE Chromaticity

Soldering methods: Reflow Soldering

MSL Level: MSL3 according to J-STD020

Packing: 8mm tape with Max. 5000/reel, ø165mm (6.5")





- **General Lighting**
- Portable Lighting
- Commercial Lighting
- **Indoor Lighting**
- Backlight for LCD



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C, RH=60%)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	240	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	I _{PF}	300	mA
Power Dissipation	P _D	816	mW
Reverse Voltage	V_R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	115	°C
Electrostatic Discharge	ESD	1000	V
Thermal Resistance (Junction to Solder Point)	R _{THJS}	21	°C/W
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+85	°C
Soldering Temperature	T _{SOL}	230/260 for 10S	°C
Colour Rendering Index	CRI	80	

Electrical & Optical Characteristics (Ta=25°C, RH=60%)

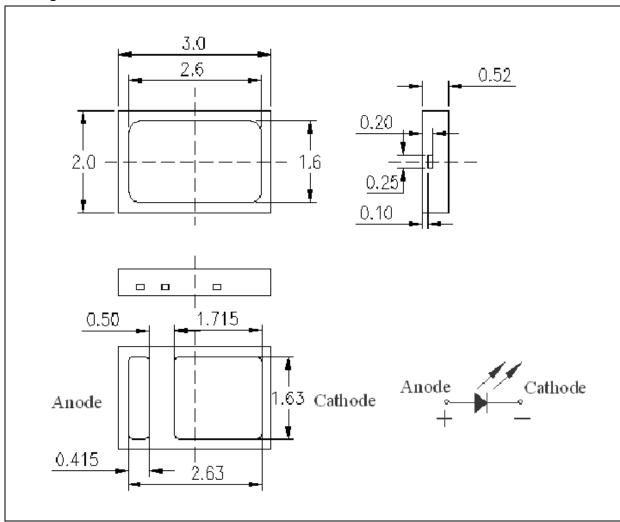
Darameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V_{F}	2.8	3.1	3.4	V	I _F =150mA	
Luminous Flux	Фу	62	70	72	lm	I _F =150mA	
Chromaticity Coordinates	Х		0.3130			I _F =150mA	
	Υ		0.3290				
Colour Temperature	ССТ	6020	6530	7040	К	I _F =150mA	
Viewing Angle	2θ _{1/2}		110		deg	I _F =150mA	

^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V



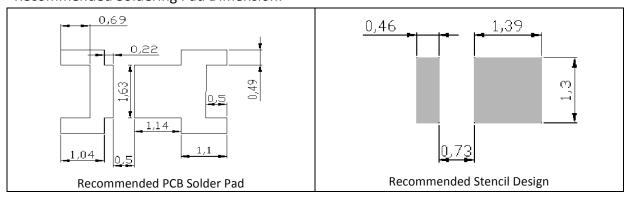
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance ± 0.5 °.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 150 \text{mA}$):

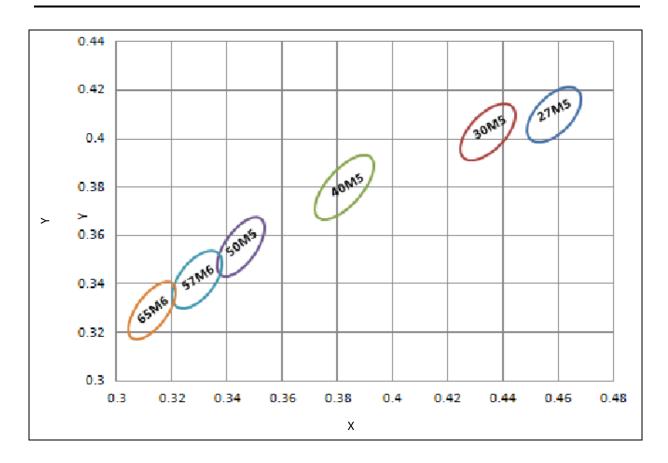
Code	Min.	Max.	Unit
1	2.8	3.0	
2	3.0	3.2	V
3	3.2	3.4	

Luminous Flux Classifications ($I_F = 150 \text{mA}$):

Code	Min.	Max.	Unit		
E9	62	66			
F1	66	70	lm		
F2	70	72			



CIE CHROMATICITY DIAGRAM:

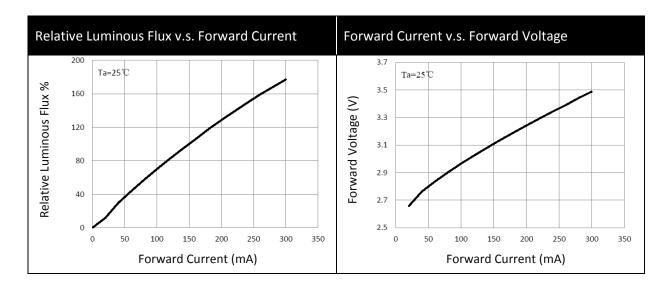


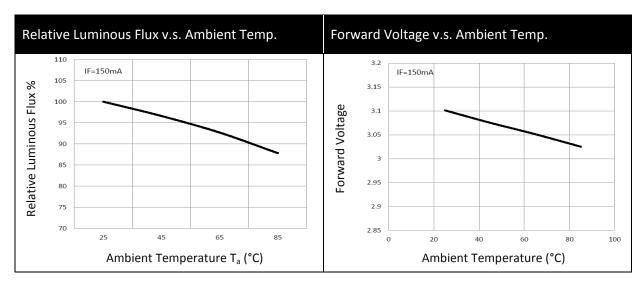
Chromaticity Coordinates Classifications (I_F = 150mA):

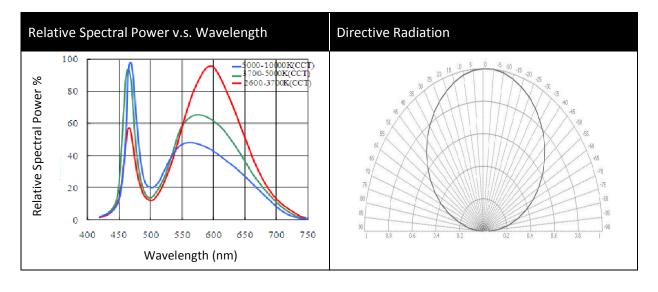
	Code	Centre		Radius		Angle
a /		X	Υ	а	b	Φ
D 0	65M6	0.3130	0.3290	0.01338	0.00570	58.34



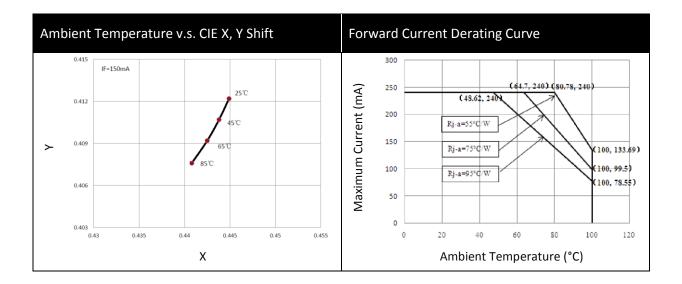
ELECTRO-OPTICAL CHARACTERISTICS:







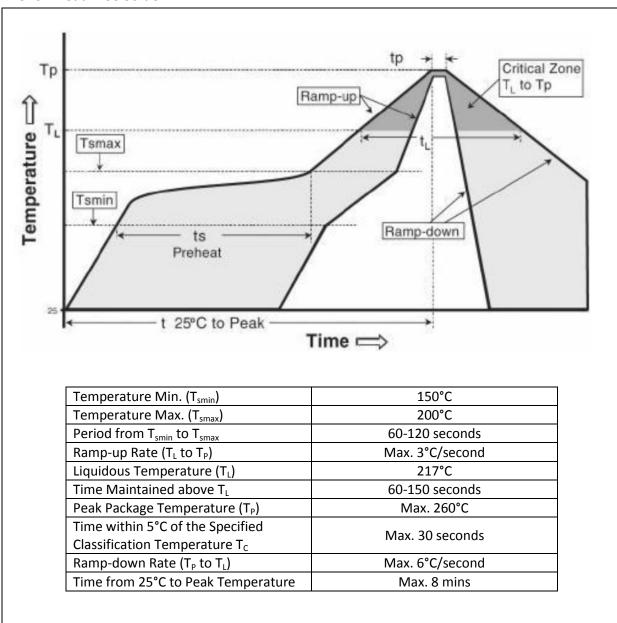






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



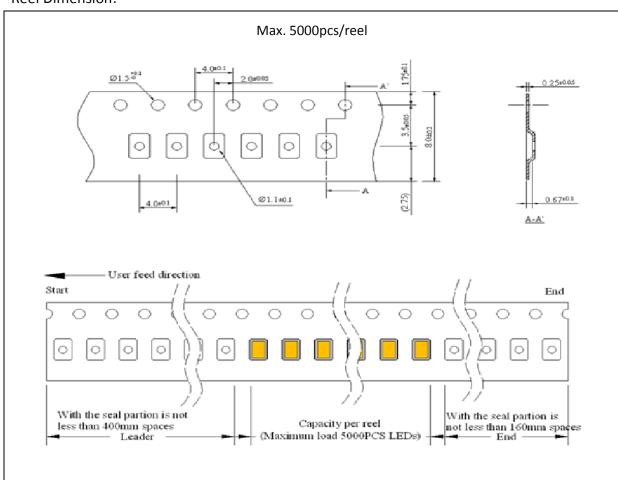
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.

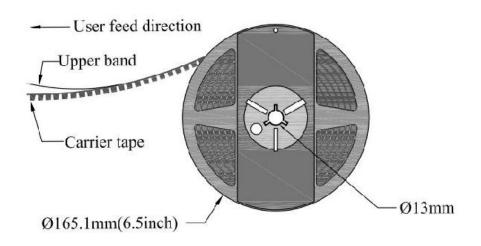


PACKING SPECIFICATION:

Reel Dimension:



- 1. Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ±0.2mm
- 2. Adhesion Strength of Cover Tape Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape.





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

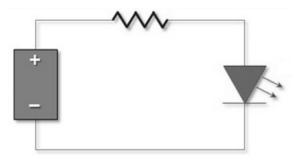
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 70±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	03/11/2015	Datasheet set-up.